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Zener Diode

### **DE5S062D0R**

# **Panasonic**

### **DE5S062D0R**

Silicon epitaxial planar type

For ESD protection DE3S062D in SSMini5 type package

#### ■ Features

- High ESD
- Halogen-free / RoHS compliant (EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)
- Marking Symbol:41
- Basic Part Number : Dual DE3S062D (Common anode)

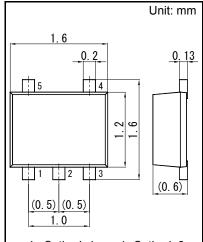
#### ■ Packaging

Embossed type (Thermo-compression sealing) 8 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

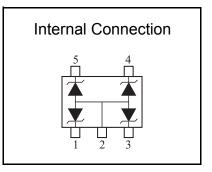
Parameter	Symbol	Rating	Unit
Total power dissipation *1	PT	150	mW
Electrostatic discharge *2	ESD	±30	kV
Junction temperature	Tj	150	°C
Operating ambient temperature	Topr	-40 to +85	°C
Storage temperature	Tstg	-55 to +150	°C

Note) \*1: PT = 150 mW achieved with a printed circuit board. (4 Diode total)



- 1. Cathode1
- 4 Cathode3
- 2. Anode1,2,3,4 5. Cathode4
- 3. Cathode2

Panasonic	SSMini5-F4-B		
JEITA	SC-107BB		
Code	SOT-665		



#### ■ Electrical Characteristics Ta = 25 $^{\circ}$ C $\pm$ 3 $^{\circ}$ C

Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Zener voltage *1, *2	VZ	IZ = 1 mA	5.89		6.51	V
Reverse current	IR	VR = 4 V			1.0	μA
Terminal Capacitance	Ct	VR = 0 V, $f = 1 MHz$		55		pF
Temperature coefficient of zener voltage *3	SZ	IZ = 1 mA		2.3		mV/°C

- Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.
  - 2. \*1: The temperature must be controlled 25°C for VZ mesurement. VZ value measured at other temperature must be adjusted to VZ (25°C)
    - \*2: VZ guaranted 20 ms after current flow.
    - \*3: Tj = 25°C to 150°C

Established: 2010-09-01 Revised: 2013-10-28

<sup>\*2:</sup> Test method:IEC61000\_4\_2(C = 150 pF,R = 330  $\Omega$ , Contact discharge:10 times)

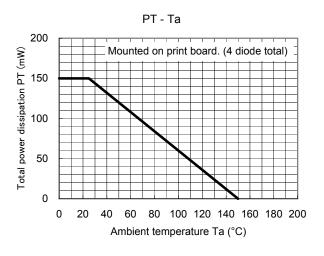
**Panasonic** 

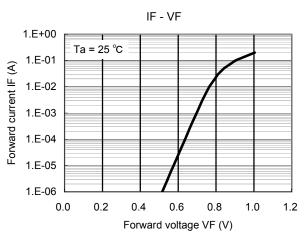
Revision. 2

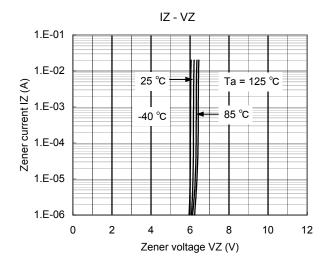
Zener Diode

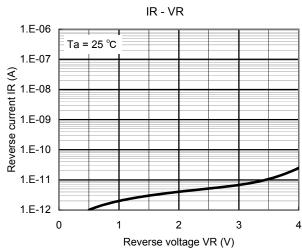
### **DE5S062D0R**

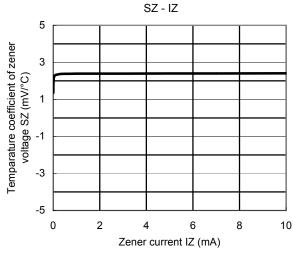
### Technical Data (reference)

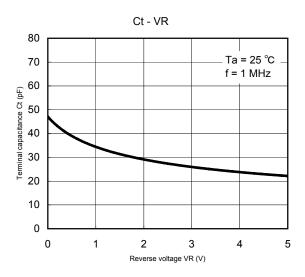












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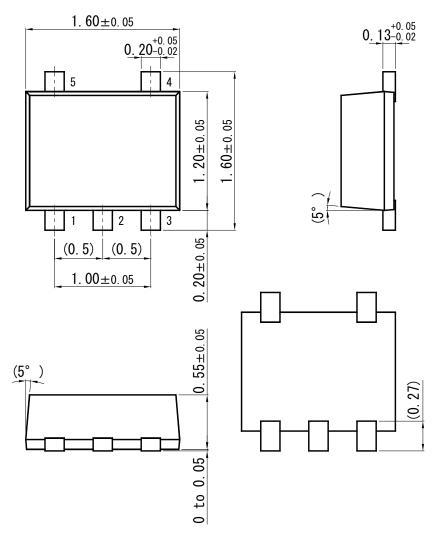
Zener Diode

### **DE5S062D0R**

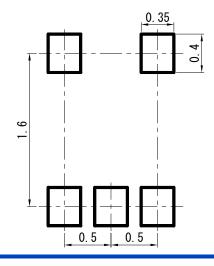
# SSMini5-F4-B

**Panasonic** 

Unit: mm



#### ■ Land Pattern (Reference) (Unit: mm)



Page 3 of 3

Established: 2010-09-01 Revised: 2013-10-28

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